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09667720

Title of Invention:

In Adhesion, Bonding And

RF Active Compositions For Use

Coating

First Named Inventor:

William J. Ryan

Domestic/Foreign Application:

Domestic Application

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TRADENTS tylesheet Version v1.1.0

Title of Invention

RF Active Compositions For Use In Adhesion, Bonding And Coating

Application Number:

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First Named Applicant:

William J. Ryan

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Submitted by:	Elec. Sign.	Sign. Capacity
Aaron L. Schwartz Registered Number: 48181	Aaron L. SCHWARTZ	Agent

Documents being submitted

Files

us-ids

21130040004c-usidst.xml

us-ids.dtd

us-ids.xsl

Comments

This IDS is being filed as five separate submissions on the same day, four

electronically and one non-electronically. This is the third of the four electronic submissions. It is believed that only one fee under 37 C.F.R. section 1.17(p) is required to cover all submissions. That fee has been included with the first electronic submission.

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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention RF Active Compositions For Use In Adhesion, Bonding And Coating

Application Number:

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First Named Applicant:

William J. Ryan

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Art Unit:

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Examiner:

Patrick Dennis Niland

Search string:

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or 5413837 or 5429702 or 5447592 or 5458233 or 5469863 or 5499484 or 5529708 or 5534097 or 5541482 or 5548056 or 5567489 or 5587226 or 5611882 or 5620656 or 5644798 or 5646076 or 5667621 or 5679423 or 5693412 or 5698061 or 5698062 or 5712044 or 5732413 or 5766400 or 5766744 or 5804021 or 5806983 or 5824606 or 5833915 or 5840405 or 5846620 or 5861211 or 5882789 or 5893219 or 5912317 or 5945486

or 5989375 or 6023856 or 6025287 or 6030490 or 6042673 or 6045648 or 6052033 or 6060145

or 6074704).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	5300749	1994-04-05	Kotikangas			
	2	5336346	1994-08-09	Meltzer et al.			
	3	5393351	1995-02-28	Kinard et al.			
	4	5403123	1995-04-04	Walters			
	5	5413837	1995-05-09	Rock et al.			
	6	5429702	1995-07-04	Grooms et al.			
	7	5447592	1995-09-05	Berce et al.			
	8	5458233	1995-10-17	Herrin			
	9	5469863	1995-11-28	Shah			

	10	5499484	1996-03-19	Herrin
	11	5529708	1996-06-25	Palmgren et al.
	12	5534097	1996-07-09	Fasano et al.
	13	5541482	1996-07-30	Siao
	14	5548056	1996-08-20	Chung
	15	5567489	1996-10-22	Allen et al.
	16	5587226	1996-12-24	Leung et al.
	17	5611882	1997-03-18	Riebel et al.
	18	5620656	1997-04-15	Wensky et al.
	19	5644798	1997-07-08	Shah
	20	5646076	1997-07-08	Bortz
	21	5667621	1997-09-16	Dougherty et al.
	22	5679423	1997-10-21	Shah
	23	5693412	1997-12-02	Walters
	24	5698061	1997-12-16	Maag
	25	5698062	1997-12-16	Sakamoto et al.
	26	5712044	1998-01-27	Fanselow et al.
	27	5732413	1998-03-31	Williams
	28	5766400	1998-06-16	Gallagher, Jr.
	29	5766744	1998-06-16	Fanselow et al.
	30	5804021	1998-09-08	Abuto et al.
	31	5806983	1998-09-15	Millon et al.
	32	5824606	1998-10-20	Dible et al.
	33	5833915	1998-11-10	Shah
	34	5840405	1998-11-24	Shusta et al.
	35	5846620	1998-12-08	Compton
	36	5861211	1999-01-19	Thakkar et al.
	37	5882789	1999-03-16	Jones et al.
,	38	5893219	1999-04-13	Smith et al.
	39	5912317	1999-06-15	Wu
	40	5945486	1999-08-31	Vargo et al.
	41	5989375	1999-11-23	Bortz
	42	6023856	2000-02-15	Brunson et al.
	43	6025287	2000-02-15	Hermann
	44	6030490	2000-02-29	Francisco et al.
	45	6042673	2000-03-28	Johnson et al.

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46	6045648	2000-04-04	Palmgren et al.	
47	6052033	2000-04-18	Schneider	
48	6060145	2000-05-09	Smith et al.	
49	6074704	2000-06-13	Le Riche et al.	

Signature

Examiner Name	Date		